

# 5A, 60V Trench Schottky Rectifiers

#### **FEATURES**

- AEC-Q101 qualified
- Patented Trench Schottky technology
- Low power loss, high efficiency
- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter
- Automotive

#### **MECHANICAL DATA**

- Case: SMPC4.6U
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 104mg (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	5	Α	
$V_{RRM}$	60	V	
I <sub>FSM</sub>	110	Α	
T <sub>J MAX</sub>	175	°C	
Package	SMPC4.6U		











ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	TSUP5M60SH	UNIT
Marking code on the device			5M60	
Repetitive peak reverse voltage		$V_{RRM}$	60	V
Reverse voltage, total rms value		$V_{R(RMS)}$	42	V
Forward current		I <sub>F</sub>	5	Α
Surge peak forward current single	8.3 ms at T <sub>A</sub> = 25°C		110	^
half sine-wave superimposed on rated load	1.0 ms at T <sub>A</sub> = 25°C	I <sub>FSM</sub>	180	A
Junction temperature		TJ	-55 to +175	°C
Storage temperature		T <sub>STG</sub>	-55 to +175	°C

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# TSUP5M60SH Taiwan Semiconductor

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	5	°C/W
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	45	°C/W
Junction-to-case thermal resistance	R <sub>eJC</sub>	9	°C/W

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	$I_F = 2.5A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.52	-	V
	$I_F = 5.0A, T_J = 25^{\circ}C$		0.59	0.64	V
	I <sub>F</sub> = 2.5A, T <sub>J</sub> = 125°C		0.45	-	V
	$I_F = 5.0A, T_J = 125$ °C		0.57	0.60	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 25°C	I <sub>R</sub>	-	200	μΑ
	T <sub>J</sub> = 125°C		-	7	mA
Junction capacitance	1 MHz, V <sub>R</sub> =4.0V	C <sub>J</sub>	346	-	pF

#### Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
TSUP5M60SH S1G	SMPC4.6U	1,500/7" Plastic reel	
TSUP5M60SH S2G	SMPC4.6U	6,000/13" Plastic reel	



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**Fig.1 Forward Current Derating Curve** 

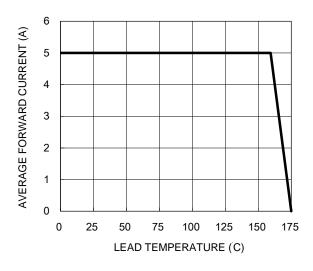


Fig.3 Typical Reverse Characteristics

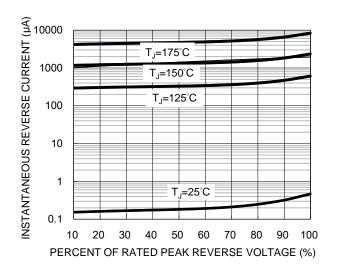


Fig.2 Typical Junction Capacitance

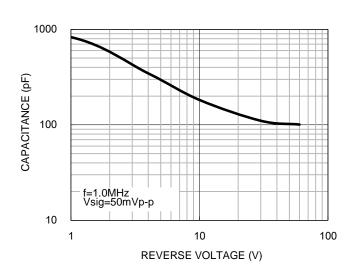


Fig.4 Typical Forward Characteristics

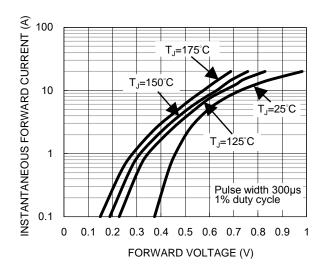
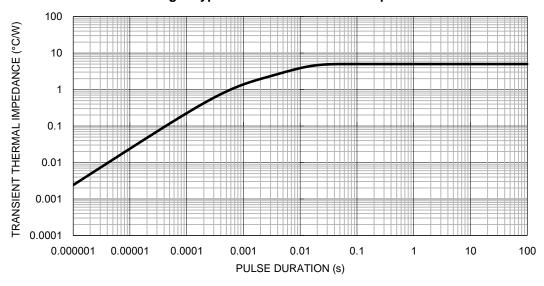


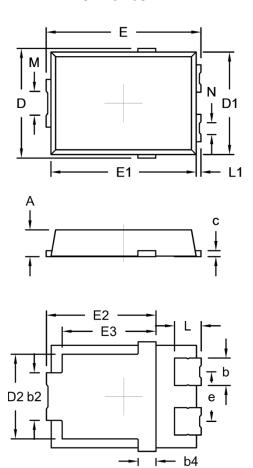
Fig.5 Typical Transient Thermal Impedance





## PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

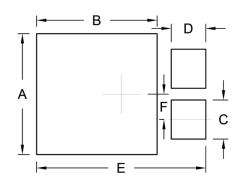
#### SMPC4.6U



DIM.	Unit (mm)		Unit (	inch)
DIIVI.	Min.	Max.	Min.	Max.
Α	1.00	1.20	0.039	0.047
b	1.05	1.35	0.041	0.053
b2	1.90	2.20	0.075	0.087
b4	0.75 (	NOM.)	0.030	(NOM.)
С	0.15	0.40	0.006	0.016
D	4.45	4.75	0.175	0.187
D1	4.25	4.35	0.167	0.171
D2	3.40	3.70	0.134	0.146
E	6.35	6.65	0.250	0.262
E1	6.05	6.15	0.238	0.242
E2	4.40	4.80	0.173	0.189
E3	3.94 (NOM.)		0.155	(NOM.)
е	2.08 (NOM.)		0.082	(NOM.)
L	0.94	1.24	0.037	0.049
L1	0.05	0.35	0.002	0.014
М	0.65	1.15	0.026	0.045
N	0.25	0.75	0.010	0.030

Package body size D1 and E1 do not include mold flash Mold flash shall not exceed 0.1mm per side

#### **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	4.95	0.195
В	4.95	0.195
С	1.60	0.063
D	1.42	0.056
E	6.95	0.274
F	1.04	0.041

### **MARKING DIAGRAM**



P/N = Marking Code YW = Date Code F = Factory Code



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